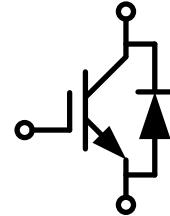


IGBT Discrete with Anti-Parallel Diode

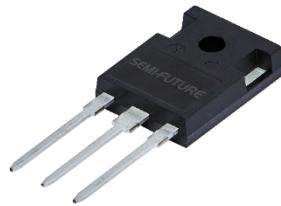
电气特性:

- 1200V 沟槽栅/场终止工艺
- 低开关损耗
- 正温度系数



典型应用:

- 充电桩
- UPS
- 逆变器



$V_{CES} = 1200V$, $I_{C\text{ nom}} = 40A$ / $I_{CRM} = 80A$

双极晶体管/IGBT

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
集电极-发射极电压 Collector-Emitter voltage	$T_{vj}=25^\circ C$	V_{CES}	1200		V
连续集电极直流电流 Continuous DC collector current	$T_C=100^\circ C$, $T_{vj\text{ max}}=175^\circ C$	$I_{C\text{ nom}}$	40		A
集电极重复峰值电流 Repetitive peak collector current	$t_p=1\text{ ms}$	I_{CRM}	80		A
总功率损耗 Total power dissipation	$T_C = 25^\circ C$, $T_{vj\text{ max}} = 175^\circ C$	P_{tot}	270		W
栅极-发射极电压 Gate emitter voltage		V_{GE}	± 20		V

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
集电极-发射极饱和电压 Collector-Emitter saturation voltage	$V_{GE}=15V$, $I_c=40A$	V_{CEsat}		1.60	2.20	V
	$V_{GE}=15V$, $I_c=40A$			1.90		
	$V_{GE}=15V$, $I_c=40A$			2.00		
栅极-发射极阈值电压 Gate-Emitter threshold voltage	$I_c=0.5mA$, $V_{GE}=V_{CE}$	$V_{GE(th)}$	4.8	5.5	6.2	
跨导 Transconductance	$V_{CE}=20V$, $I_c=40A$	G_{fs}		27		S

输入电容 Input capacitance	f=1 MHz, V _{CE} =25 V, V _{GE} =0 V T _{vj} =25°C	C _{ies}		2.56		nF
输出电容 Output capacitance		C _{oes}		0.16		
反向传输电容 Reverse transfer capacitance		C _{res}		0.12		
集电极-发射极截止电流 Collector-emitter cut-off current	V _{CE} =1200V , V _{GE} = 0 V T _{vj} =25°C	I _{CES}			1	mA
栅极-发射极漏电流 Gate-emitter leakage current	V _{CE} =0 V, V _{GE} = 20 V T _{vj} =25°C	I _{GES}			200	nA
开通延迟时间 Turn-on delay time	I _c =40A, V _{CE} =600 V V _{GE} =±15 V, R _G =12Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d on}		84 80 76	
上升时间 Rise time	I _c =40A, V _{CE} =600 V V _{GE} =±15 V, R _G =12Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _r		50 60 60	
关断延迟时间 Turn-off delay time	I _c =40A, V _{CE} =600 V V _{GE} =±15 V, R _G =12Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d off}		264 298 304	ns
下降时间 Fall time	I _c =40A, V _{CE} =600 V V _{GE} =±15 V, R _G =15Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _f		203 297 283	
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	I _c =40A, V _{CE} =600 V V _{GE} =±15 V, R _G =12Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{on}		2.50 4.15 4.50	mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	I _c =40A, V _{CE} =600 V V _{GE} =±15 V, R _G =12Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{off}		1.50 1.95 2.10	
结-外壳热阻 IGBT thermal resistance, junction		R _{thJC}		0.38		K/W
在开关状态下温度 Temperature under switching conditions		T _{vj op}	-40		150	°C

二极管/Diode

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
反向重复峰值电压 Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	1200	V
连续正向直流电流 Continuous DC forward current	T _C =100°C, T _{vj max} =175°C	I _F	8	A
正向重复峰值电流 Repetitive peak forward current	t _p =1ms	I _{FRM}	16	A

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
正向电压 Forward voltage	I _F =8A, V _{GE} =0V	V _F	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	1.73 1.53 1.48	2.8	V
	I _F =8A, V _{GE} =0V					
	I _F =8A, V _{GE} =0V					
反向恢复峰值电流 Peak reverse recovery current	I _F =8A, -di _F /dt=356A/μs(T _{vj} =150°C)	I _{RM}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	18 22 25	A	A
	V _R =600V, V _{GE} =-15V					
	T _{vj} =150°C					
反向恢复电荷 Reverse Recovered charge	I _F =8A, -di _F /dt=356A/μs(T _{vj} =150°C)	Q _{rr}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	2.45 3.38 3.73	μC	μC
	V _R =600V, V _{GE} =-15V					
	T _{vj} =150°C					
反向恢复时间 Reverse Recovery Time	I _F =8A, -di _F /dt=356A/μs(T _{vj} =150°C)	t _{rr}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	186 207 218	ns	ns
	V _R =600V, V _{GE} =-15V					
	T _{vj} =150°C					
反向恢复损耗 (每脉冲) Reverse recovered energy	I _F =8A, -di _F /dt=356A/μs(T _{vj} =150°C)	E _{rec}	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	0.65 0.88 0.95	mJ	mJ
	V _R =600V, V _{GE} =-15V					
	T _{vj} =150°C					
结-外壳热阻 Diode thermal resistance, junction		R _{thJC}		0.45		K/W
在开关状态下温度 Temperature under switching conditions		T _{vj op}	-40		175	°C

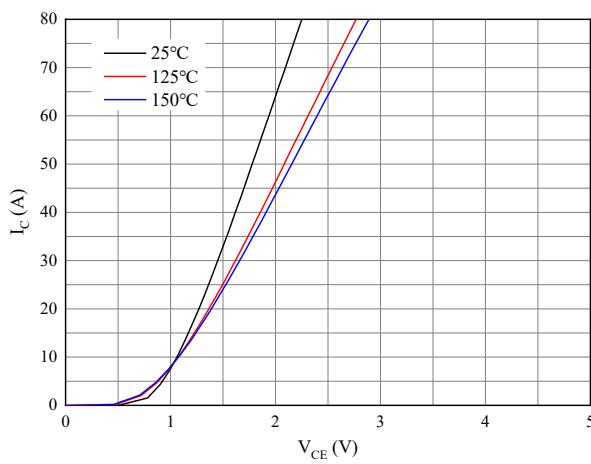
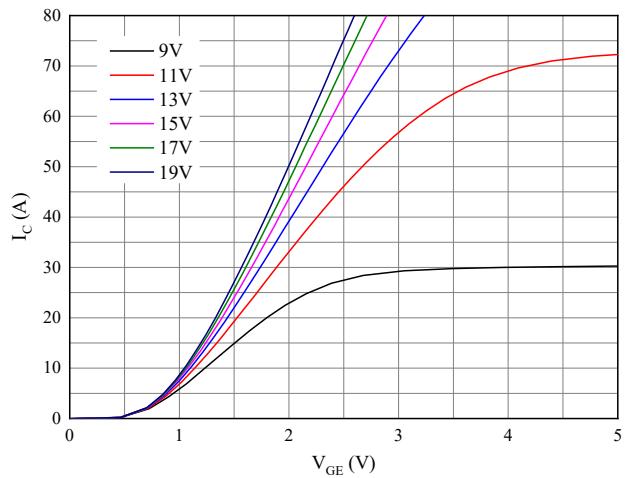
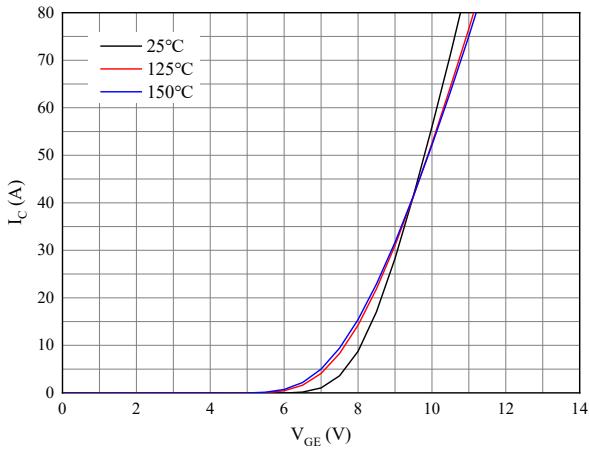
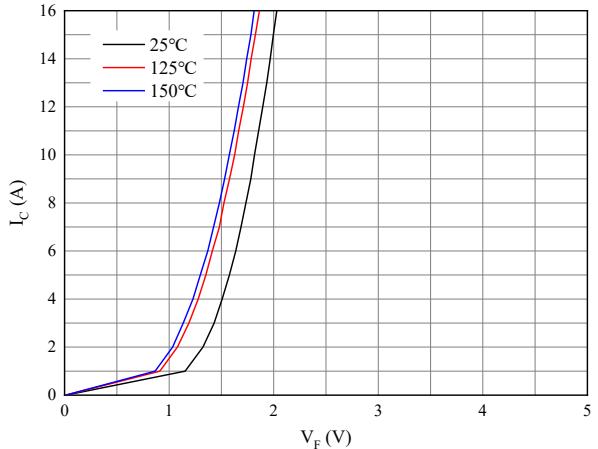
图 1. 典型输出特性 ($V_{GE}=15V$)Figure 1. Typical output characteristics ($V_{GE}=15V$)图 2. 典型输出特性 ($T_{vj}=150^{\circ}\text{C}$)Figure 2. Typical output characteristics ($T_{vj}=150^{\circ}\text{C}$)图 3. 典型传输特性($V_{CE}=20\text{V}$)Figure 3. Typical transfer characteristic($V_{CE}=20\text{V}$)

图 4. 正向偏压特性 二极管

Figure 4. Forward characteristic of Diode

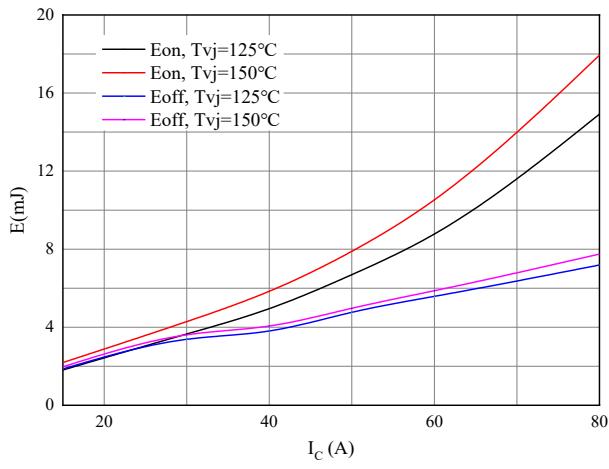


图 5. 开关损耗

Figure 5. Switching losses of IGBT

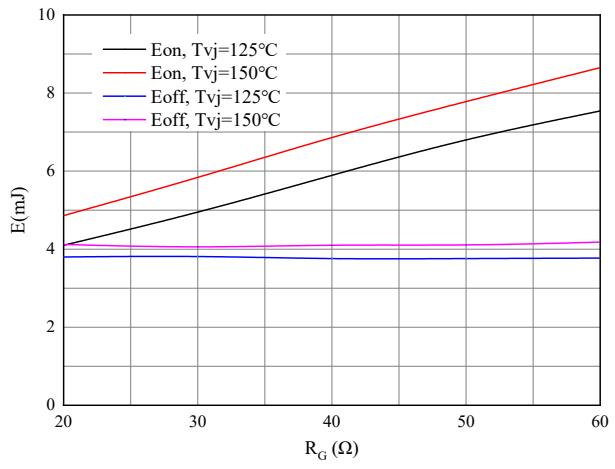
 $V_{GE}=\pm 15\text{V}$, $R_{Gon}=12\Omega$, $R_{Goff}=12\Omega$, $V_{CE}=600\text{V}$ 

图 6. 开关损耗

Figure 6. Switching losses of IGBT

 $V_{GE}=\pm 15\text{V}$, $I_C=8\text{A}$, $V_{CE}=600\text{V}$

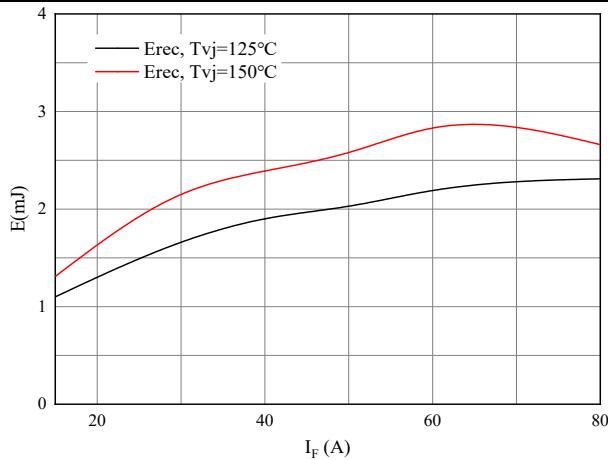


图 7. 开关损耗 二极管

Figure 7. Switching losses of Diode

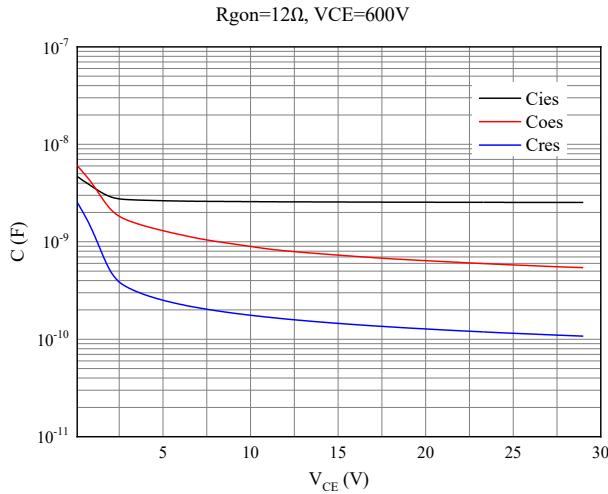


图 9. 电容特性

Figure 9. Capacitance characteristic

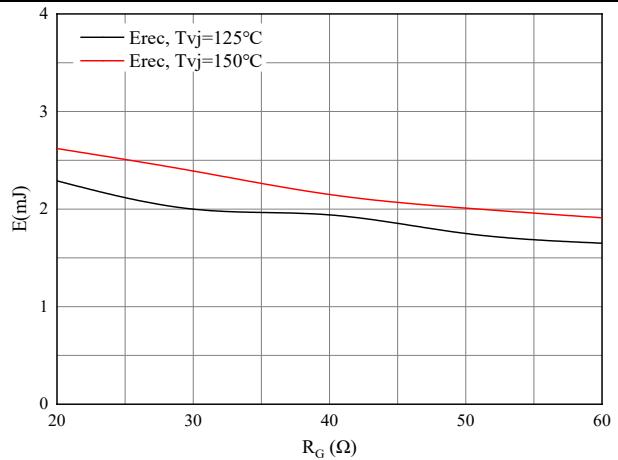
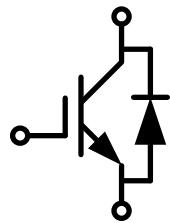


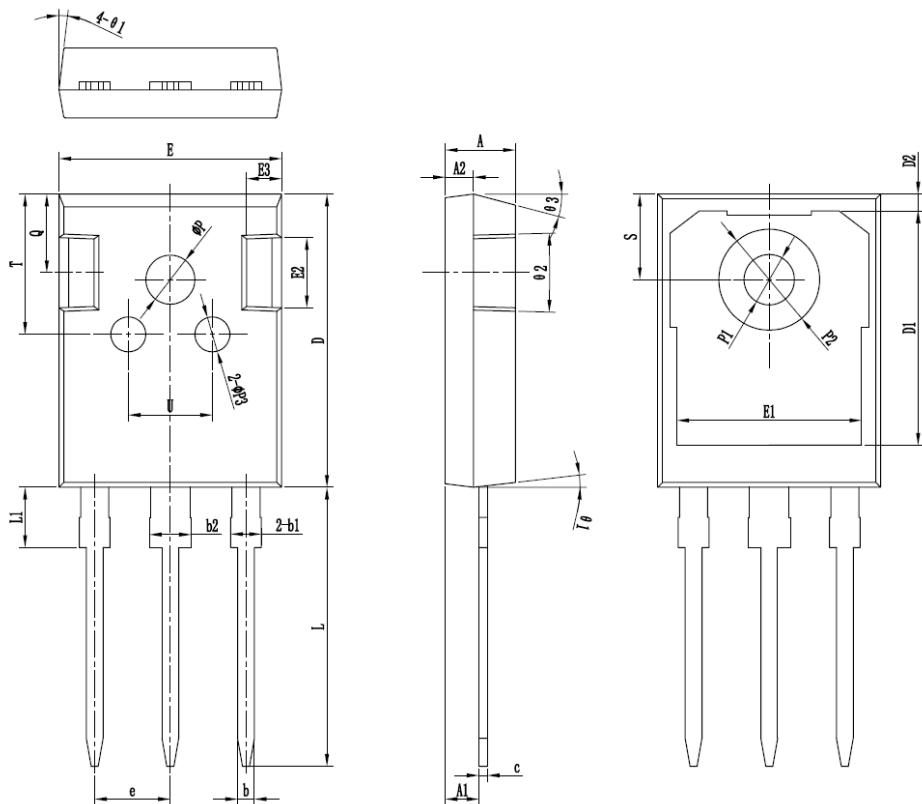
图 8. 开关损耗 二极管

Figure 8. Switching losses of Diode

接线图 / Circuit diagram



封装尺寸 / Package outlines



符号	单位:mm		
	MIN	NOM	MAX
* a_1	4.90	5.00	5.10
* a_{11}	2.31	2.41	2.51
A_2	1.90	2.00	2.10
a_b	1.15	1.20	1.25
* a_{b1}	1.95	2.10	2.25
* a_{b2}	2.95	3.10	3.25
a_c	0.55	0.60	0.65
* a_d	20.90	21.00	21.10
D_1	16.35	16.55	16.75
D_2	1.05	1.20	1.35
* E_6	15.70	15.80	15.90
E_1	13.10	13.25	13.40
E_2	4.90	5.00	5.10
E_3	2.40	2.50	2.60
e_0	5.40	5.44	5.48
* a_{e1}	19.80	19.92	20.10
* a_{f1}	-	-	4.30
* a_{f2}	3.70	3.80	3.90
* a_{f1}	3.50	3.60	3.70
* a_{f2}	7.00	7.20	7.40
* a_{f3}	2.40	2.50	2.60
q	5.60	5.80	6.00
* s_5	6.05	6.15	6.25
T	9.80	10.00	10.20
U	6.00	6.20	6.40
θ_1	5°	7°	9°
θ_2	1°	3°	5°
θ_3	13°	15°	17°

*为关键管控尺寸